

1. General description

The CBT3245A provides eight bits of high-speed TTL-compatible bus switching. The low ON resistance of the switch allows connections to be made with minimal propagation delay.

The CBT3245A is organized as one 8-bit bus switches with one output enable (\overline{OE}) input. When \overline{OE} is LOW, the switch is on and port A is connected to the B port. When \overline{OE} is HIGH, each switch is disabled. The CBT3245A is characterized for operation from -40 °C to +85 °C.

2. Features and benefits

- 5 Ω switch connection between two ports
- TTL-compatible control input levels
- Multiple package options
- Latch-up protection exceeds 500 mA per JESD78
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115B exceeds 150 V
 - CDM JESD22-C101C exceeds 1000 V

3. Ordering information

Table 1. Ordering information

Type number	Package								
	Temperature range	Name	Description	Version					
CBT3245AD	–40 °C to +85 °C	SO20	plastic small outline package; 20 leads; body width 7.5 mm	SOT163-1					
CBT3245ADB	–40 °C to +85 °C	SSOP20	plastic shrink small outline package; 20 leads; body width 5.3 mm	SOT339-1					
CBT3245ADS	–40 °C to +85 °C	SSOP20[1]	plastic shrink small outline package; 20 leads; body width 3.9 mm; lead pitch 0.635 mm	SOT724-1					
CBT3245APW	–40 °C to +85 °C	TSSOP20	plastic thin shrink small outline package; 20 leads; body width 4.4 mm	SOT360-1					
CBT3245ABQ	–40 °C to +85 °C	DHVQFN20	plastic dual-in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body $2.5 \times 4.5 \times 0.85$ mm	SOT764-1					

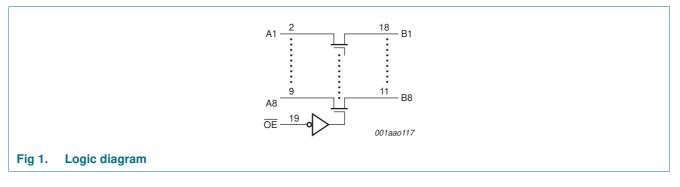
[1] Also known as QSOP20 package



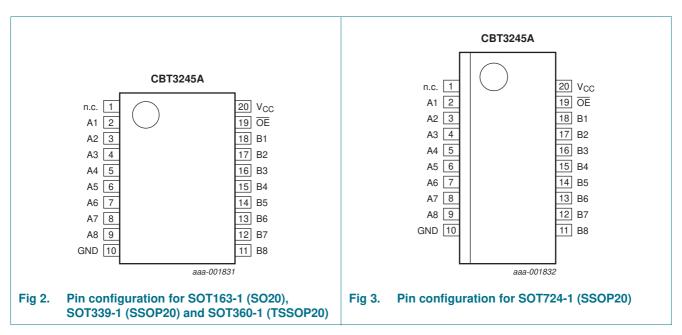
Octal bus switch

CBT3245A

4. Functional diagram



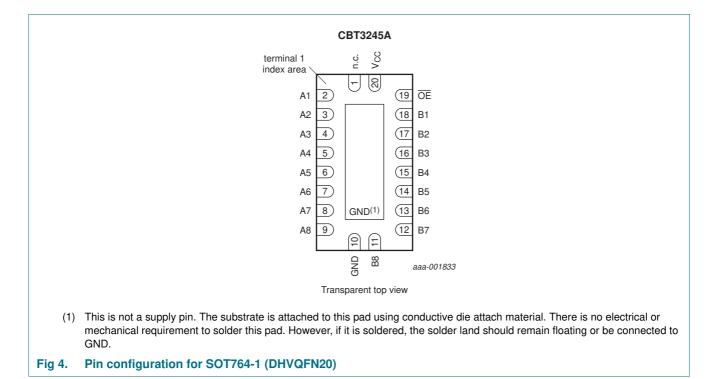
5. Pinning information



5.1 Pinning

CBT3245A

Octal bus switch



5.2 Pin description

Table 2.	Pin description	
Symbol	Pin	Description
n.c.	1	not connected
A1 to A8	2, 3, 4, 5, 6, 7, 8, 9	data input/output (A port)
GND	10	ground (0 V)
B1 to B8	18, 17, 16, 15, 14, 13, 12, 1	1 data input/output (B port)
OE	19	output enable input (active LOW)
V _{CC}	20	positive supply voltage

6. Functional description

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Table 3.	Function selection ^[1]	
Input OE		Input/output
OE		An, Bn
L		An = Bn
Н		Z

[1] H = HIGH voltage level; L = LOW voltage level; Z = high-impedance OFF-state.

CBT3245A Product data shee

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).^[1] $T_{amb} = -40 \ ^{\circ}C$ to +85 $^{\circ}C$, unless otherwise specified.

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Symbol	Parameter	Conditions	Min	Мах	Unit
V _{CC}	supply voltage		-0.5	+7.0	V
VI	input voltage		[2] -0.5	+7.0	V
I _{OK}	output clamping current	$V_{O} < 0 V$	-50	-	mA
Vo	output voltage		<u>[2]</u> –0.5	+7.0	V
lo	output current	$V_{O} < 0 V$	-	±128	mA
I _{IK}	input clamping current	$V_I = 0 V$	-50	-	mA
T _{stg}	storage temperature		-65	+150	°C

 Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under <u>Section 8</u> is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

[2] The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

8. Recommended operating conditions

Table 5.Operating conditions

All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC}	supply voltage		4.0	-	5.5	V
V _{IH}	HIGH-level input voltage		2.0	-	-	V
V _{IL}	LOW-level input voltage		-	-	0.8	V
T _{amb}	ambient temperature	operating in free air	-40	-	+85	°C

9. Static characteristics

Table 6. Static characteristics

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	T _{amb} =	Unit		
			Min	Typ <mark>[1]</mark>	Max	
V _{IK}	input clamping voltage	$V_{CC} = 4.5 \text{ V}; \text{ I}_{\text{I}} = -18 \text{ mA}$	-	-	-1.2	V
l _l	input leakage current	V_{CC} = 5.5 V; V_I = GND or 5.5 V	-	-	±5	μA
I _{CC}	supply current	$V_{CC} = 5.5 \text{ V}; I_O = 0 \text{ mA};$ $V_I = V_{CC} \text{ or GND}$	-	1	3	μ A
ΔI_{CC}	additional supply current	per input pin; $V_{CC} = 5.5$ V; one input at [2] 3.4 V, other inputs at V_{CC} or GND	-	-	3.5	mA
CI	input capacitance	control pins; $V_I = 3 V \text{ or } 0 V$	-	3.2	-	рF
C _{io(off)}	off-state input/output capacitance	port off; $V_I = 3 V \text{ or } 0 V$; $\overline{OE} = V_{CC}$	-	6.6	-	pF

Octal bus switch

Voltages are referenced to GND (ground = $0 V$).									
Symbol	Parameter	Conditions	T _{amb} =	–40 °C to -	+85 °C	Unit			
				Min	Typ <mark>[1]</mark>	Max			
R _{ON}	ON resistance	$V_{CC} = 4.5 \ V; \ V_I = 0 \ V; \ I_I = 64 \ mA$	[3]	-	5	7	Ω		
		$V_{CC} = 4.5 \ V; \ V_I = 0 \ V; \ I_I = 30 \ mA$	[3]	-	5	7	Ω		
		$V_{CC} = 4.5 \ V; \ V_I = 2.4 \ V; \ I_I = -15 \ mA$	[3]	-	10	15	Ω		

Static characteristics ... continued Table 6.

[1] All typical values are at $V_{CC} = 5 \text{ V}$, $T_{amb} = 25 \text{ °C}$.

[2] This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.

Measured by the voltage drop between the An and the Bn terminals at the indicated current through the switch. ON resistance is [3] determined by the lowest voltage of the two (An or Bn) terminals.

10. Dynamic characteristics

Table 7. **Dynamic characteristics**

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 7.

Symbol	Parameter	Conditions		$T_{amb} = -40$	Unit	
				Min	Max	
t _{pd}	propagation delay	An, Bn to Bn, An; see Figure 5	[1][2]			
		$V_{CC}=5.0~V\pm0.5~V$		-	0.25	ns
t _{en}	enable time	OE to An or Bn; see Figure 6	[2]			
		$V_{CC}=5.0~V\pm0.5~V$		1.0	5.9	ns
t _{dis}	disable time	OE to An or Bn; see Figure 6	[2]			
		$V_{CC}=5.0~V\pm0.5~V$		1.0	6.0	ns

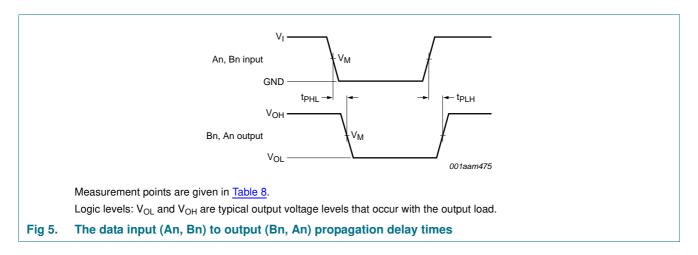
[1] The propagation delay is the calculated RC time constant of the typical ON resistance of the switch and the specified load capacitance, when driven by an ideal voltage source (zero output impedance).

[2] t_{pd} is the same as t_{PLH} and t_{PHL}.

ten is the same as tPZL and tPZH.

t_{dis} is the same as t_{PLZ} and t_{PHZ}.

11. Waveforms



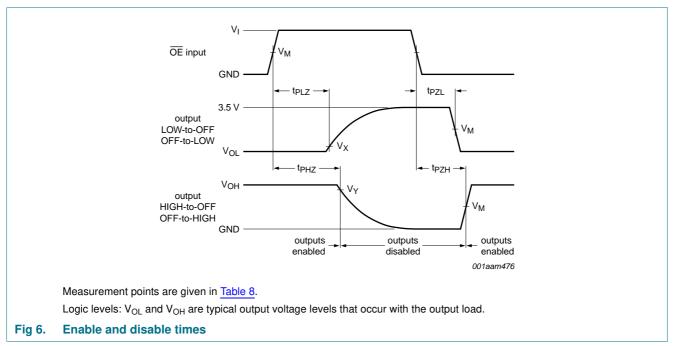


Table 8. Measurement points

Supply voltage	Input		Output			
V _{cc}	VI	V _M	V _M	V _X	V _Y	
$V_{CC}=5.0~V\pm0.5~V$	GND to 3.0 V	1.5 V	1.5 V	V _{OL} + 0.3 V	V _{OH} – 0.3 V	

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12. Test information

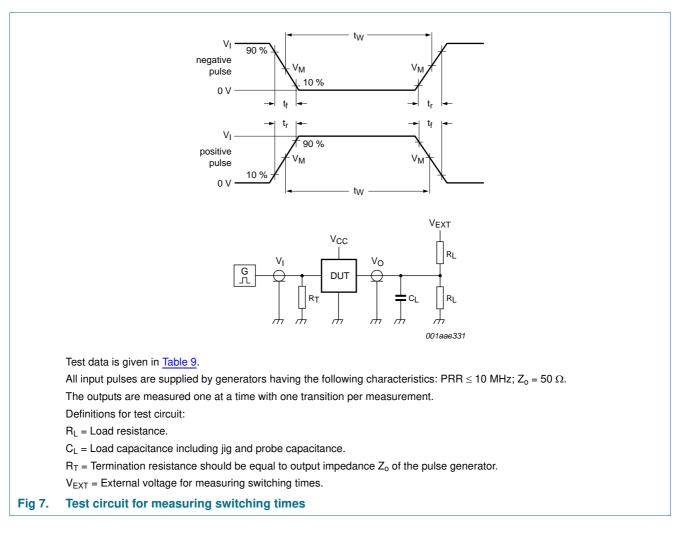


Table 9. Test data

Supply voltage	Input		Load		V _{EXT}		
	VI	t _r , t _f	CL	RL	t _{PLH} , t _{PHL}	t _{PLZ} , t _{PZL}	t _{PHZ} , t _{PZH}
$V_{CC}=5.0~V\pm0.5~V$	GND to 3.0 V	\leq 2.5 ns	50 pF	500 Ω	open	7.0 V	open

CBT3245A Octal bus switch

13. Package outline

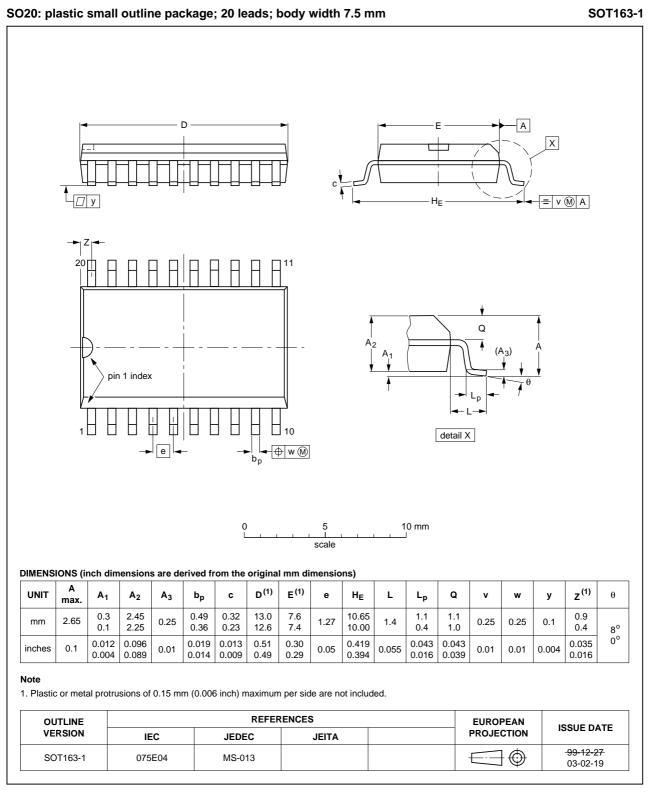


Fig 8. Package outline SOT163-1 (SO20)

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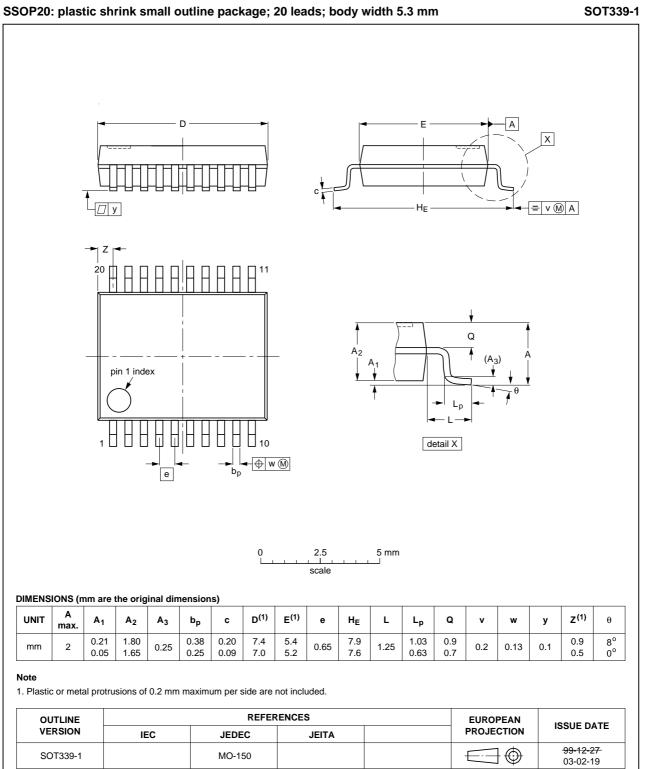
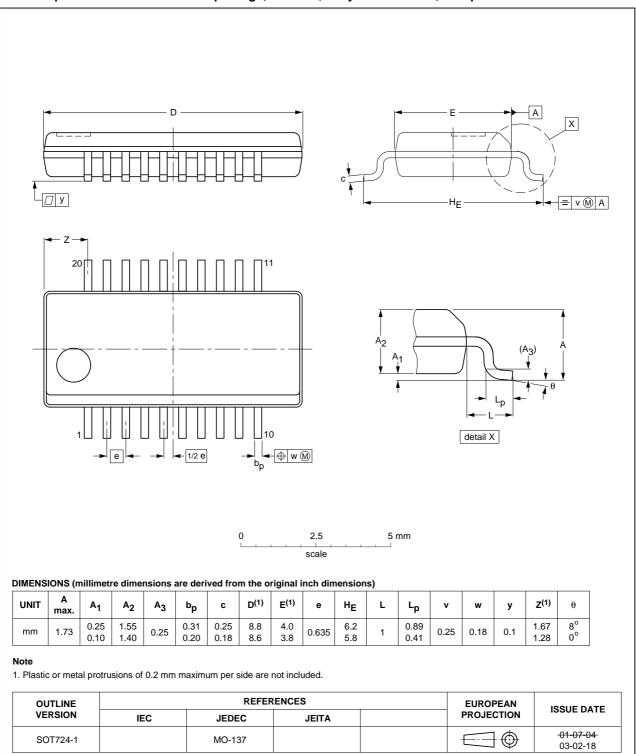


Fig 9. Package outline SOT339-1 (SSOP20)

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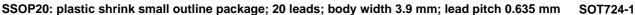


Fig 10. Package outline SOT724-1 (SSOP20)

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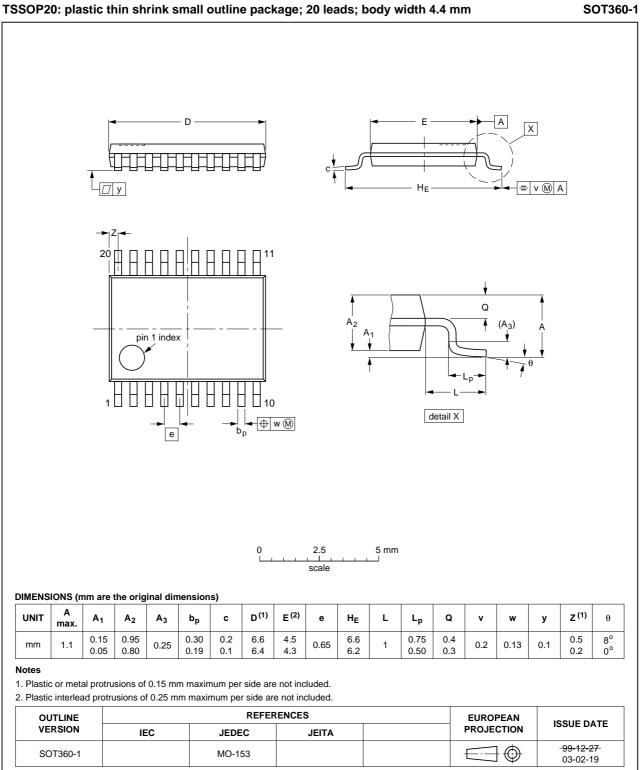
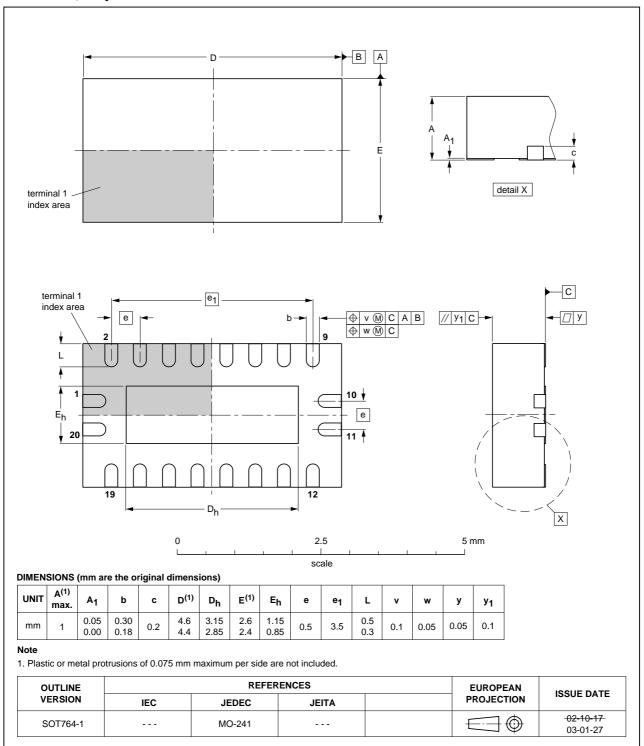


Fig 11. Package outline SOT360-1 (TSSOP20)

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DHVQFN20: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 x 4.5 x 0.85 mm SOT764-1

Fig 12. Package outline SOT764-1 (DHVQFN20)

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14. Abbreviations

Table 10.	Abbreviations
Acronym	Description
CDM	Charged Device Model
ESD	ElectroStatic Discharge
DUT	Device Under Test
HBM	Human Body Model
MM	Machine Model
PRR	Pulse Rate Repetition
TTL	Transistor-Transistor Logic

15. Revision history

Table 11. Revision	on history							
Document ID	Release date	Data sheet status	Change notice	Supersedes				
CBT3245A v.3	20120105	Product data sheet	-	CBT3245A v.2				
Modifications:	 The format of NXP Semicor 		edesigned to comply with	the new identity guidelines of				
	 Legal texts I 	have been adapted to the ne	ew company name where	appropriate.				
	 Marking cod 	 Marking code removed from order information section. 						
	 Description 	of C _I and C _{I/O} corrected (err	ata).					
CBT3245A v.2	20020627	Product data sheet	-	CBT3245A v.1				
CBT3245A v.1	20020218	Product data sheet	-	-				

16. Legal information

16.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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[2] The term 'short data sheet' is explained in section "Definitions".

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